

Features

- Epitaxial Planar Die Construction
- Complementary NPN Type Available (DCP68)
- Ideally Suited for Automated Assembly Processes
- Ideal for Medium Power Switching or Amplification Applications
- **Lead Free By Design/RoHS Compliant (Note 1)**
- **"Green" Device (Note 2)**

Mechanical Data

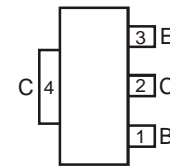
- Case: SOT-223
- Case Material: Molded Plastic, "Green Molding" Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Finish - Matte Tin annealed over Copper leadframe (Lead Free Plating). Solderable per MIL-STD -202, Method 208
- Marking Information: See Page 4
- Ordering Information: See Page 4
- Weight: 0.112 grams



Top View



Device Schematic


 Top View
Pin Out Configuration

Maximum Ratings @ $T_A = 25^\circ\text{C}$ unless otherwise specified

Characteristic	Symbol	Value	Units
Collector-Base Voltage	V_{CBO}	-25	V
Collector-Emitter Voltage	V_{CEO}	-20	V
Emitter-Base Voltage	V_{EBO}	-5.0	V
Collector Current	I_C	-1.0	A
Peak Pulse Current	I_{CM}	-2.0	A

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 3) @ $T_A = 25^\circ\text{C}$	P_D	1	W
Thermal Resistance, Junction to Ambient Air (Note 3) @ $T_A = 25^\circ\text{C}$	$R_{\theta JA}$	125	$^\circ\text{C}/\text{W}$
Power Dissipation (Note 4) @ $T_A = 25^\circ\text{C}$	P_D	2	W
Thermal Resistance, Junction to Ambient Air (Note 4) @ $T_A = 25^\circ\text{C}$	$R_{\theta JA}$	62.5	$^\circ\text{C}/\text{W}$
Operating and Storage Temperature Range	T_J, T_{STG}	-55 to +150	$^\circ\text{C}$

- Notes:
1. No purposefully added lead.
 2. Diodes Inc.'s "Green" Policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.
 3. Device mounted on FR-4 PCB; pad layout as shown on page 4 or in Diodes Inc. suggested pad layout document AP02001, which can be found on our website at <http://www.diodes.com/datasheets/ap02001.pdf>.
 4. Device mounted on FR-4 PCB with 1in.² copper pad layout.

Electrical Characteristics @ $T_A = 25^\circ\text{C}$ unless otherwise specified

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
OFF CHARACTERISTICS						
Collector-Base Breakdown Voltage	$V_{(BR)CBO}$	-25	—	—	V	$I_C = -10\mu\text{A}, I_E = 0$
Collector-Emitter Breakdown Voltage (Note 5)	$V_{(BR)CEO}$	-20	—	—	V	$I_C = -1.0\text{mA}, I_B = 0$
Emitter-Base Breakdown Voltage	$V_{(BR)EBO}$	-5.0	—	—	V	$I_E = -10\mu\text{A}, I_C = 0$
Collector-Base Cutoff Current	I_{CBO}	—	—	-100 -10	nA μA	$V_{CB} = -25\text{V}, I_E = 0$ $V_{CB} = -25\text{V}, I_E = 0, T_A = 150^\circ\text{C}$
Emitter-Base Cutoff Current	I_{EBO}	—	—	-100	nA	$V_{EB} = -5.0\text{V}, I_C = 0$
ON CHARACTERISTICS (Note 5)						
DC Current Gain	DCP69, DCP69-16, DCP69-25	50 60	— —	— —	—	$V_{CE} = -10\text{V}, I_C = -5.0\text{mA}$ $V_{CE} = -1.0\text{V}, I_C = -1.0\text{A}$
	DCP69	85	—	375	—	$V_{CE} = -1.0\text{V}, I_C = -500\text{mA}$
	DCP69-16	100	—	250	—	$V_{CE} = -1.0\text{V}, I_C = -500\text{mA}$
	DCP69-25	160	—	375	—	$V_{CE} = -1.0\text{V}, I_C = -500\text{mA}$
Collector-Emitter Saturation Voltage	$V_{CE(SAT)}$	—	—	-0.5	V	$I_C = -1.0\text{A}, I_B = -100\text{mA}$
Base-Emitter Turn-On Voltage	$V_{BE(ON)}$	—	—	-0.7 -1.0	V	$V_{CE} = -10\text{V}, I_C = -5.0\text{mA}$ $V_{CE} = -1.0\text{V}, I_C = -1.0\text{A}$
SMALL SIGNAL CHARACTERISTICS						
Current Gain-Bandwidth Product	f_T	40	200	—	MHz	$V_{CE} = -5.0\text{V}, I_C = -50\text{mA}, f = 100\text{MHz}$
Output Capacitance	C_{obo}	—	17	—	pF	$V_{CB} = -10\text{V}, f = 1\text{MHz}$

Notes: 5. Measured under pulsed conditions. Pulse width = $300\mu\text{s}$. Duty cycle $\leq 2\%$.

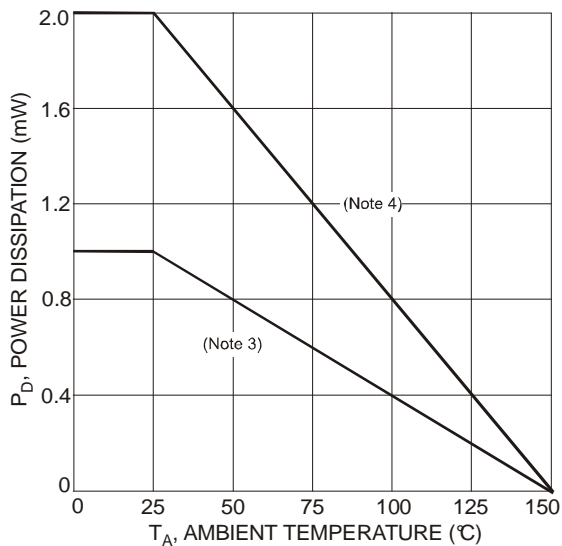


Fig. 1 Power Dissipation vs. Ambient Temperature (Note 3)

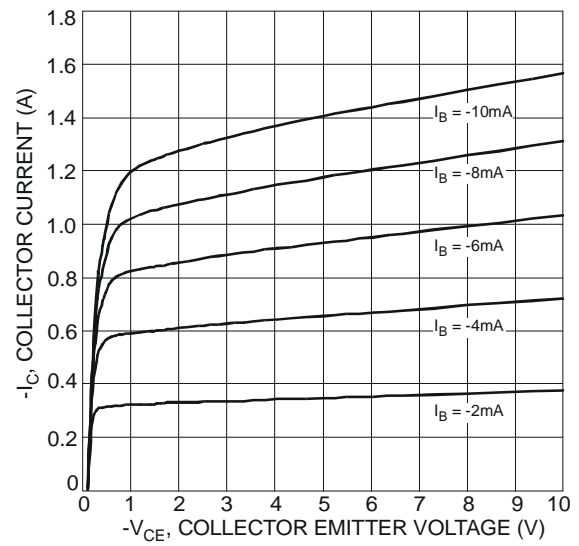


Fig. 2 Typical Collector Current vs. Collector-Emitter Voltage

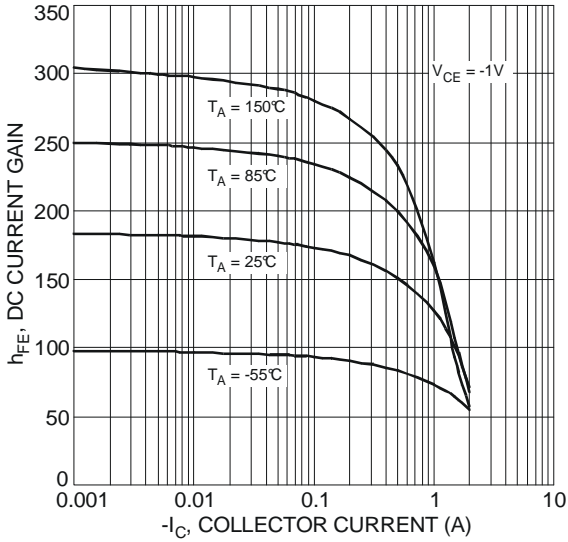


Fig. 3 Typical DC Current Gain vs. Collector Current (DCP69-16)

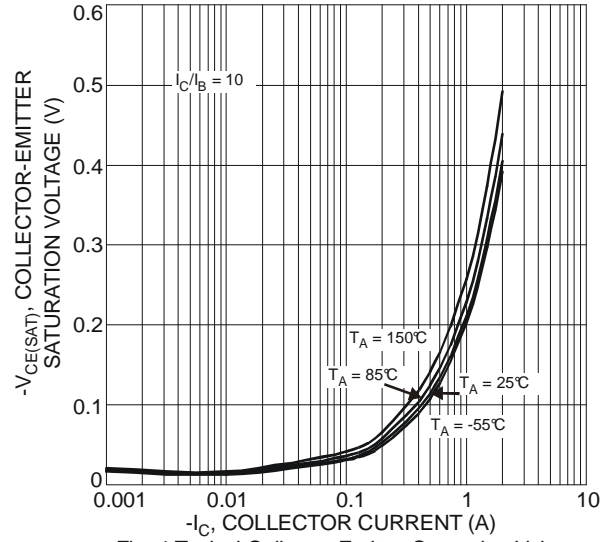


Fig. 4 Typical Collector-Emitter Saturation Voltage vs. Collector Current

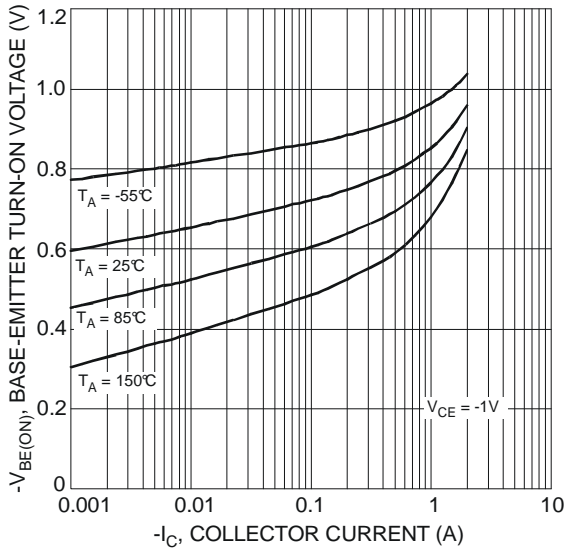


Fig. 5 Typical Base-Emitter Turn-On Voltage vs. Collector Current

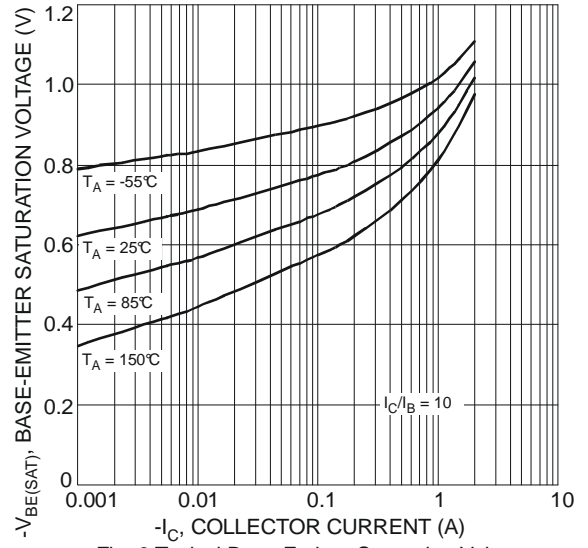


Fig. 6 Typical Base-Emitter Saturation Voltage vs. Collector Current

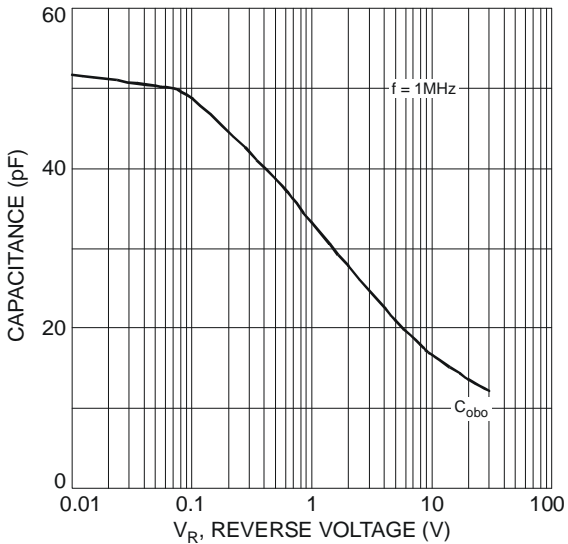


Fig. 7 Typical Output Capacitance Characteristics

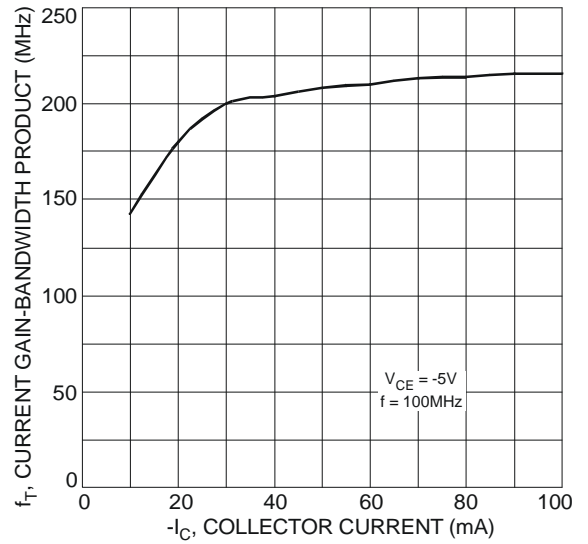


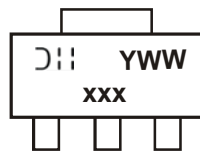
Fig. 8 Typical Gain-Bandwidth Product vs. Collector Current

Ordering Information (Note 6)

Part Number	Case	Packaging
DCP69-13	SOT-223	2500/Tape & Reel
DCP69-16-13	SOT-223	2500/Tape & Reel
DCP69-25-13	SOT-223	2500/Tape & Reel

Notes: 6. For packaging details, go to our website at <http://www.diodes.com/datasheets/ap02007.pdf>.

Marking Information



xxx = Product Type Marking Code

P12 = DCP69

P12-16 = DCP69-16

P12-25 = DCP69-25

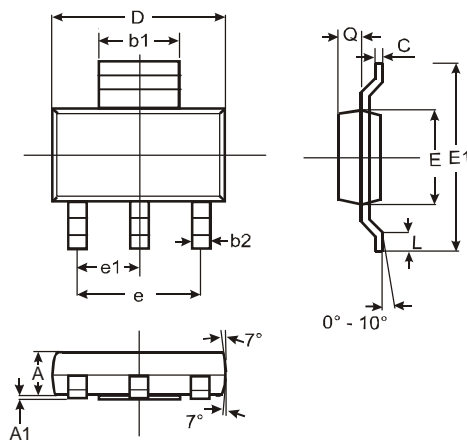
DII = Manufacturer's code marking

YWW = Date Code Marking

Y = Last digit of year (ex: 7 = 2007)

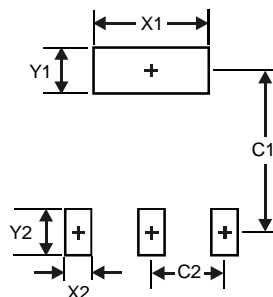
WW = Week code 01 - 52

Package Outline Dimensions



SOT-223			
Dim	Min	Max	Typ
A	1.55	1.65	1.60
A1	0.010	0.15	0.05
b1	2.90	3.10	3.00
b2	0.60	0.80	0.70
C	0.20	0.30	0.25
D	6.45	6.55	6.50
E	3.45	3.55	3.50
E1	6.90	7.10	7.00
e	—	—	4.60
e1	—	—	2.30
L	0.85	1.05	0.95
Q	0.84	0.94	0.89
All Dimensions in mm			

Suggested Pad Layout



Dimensions	Value (in mm)
X1	3.3
X2	1.2
Y1	1.6
Y2	1.6
C1	6.4
C2	2.3

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